

DATE 26 FEB 2016

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS.
- DIMENSION b APPLIES TO PLATED TERMINALS.
- COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.33	0.43	
A1	0.00	0.05	
А3	0.127 REF		
b	0.17	0.27	
D	0.80 BSC		
D2	0.20	0.30	
E	0.80 BSC		
E2	0.20	0.30	
е	0.48 BSC		
L	0.17	0.27	
L1	-	0.10	
L2	0.06 REF		

GENERIC MARKING DIAGRAM*



XX = Specific Device Code = Date Code

*This information is generic. Please refer to device data sheet for actual part marking.

Pb-Free indicator, "G" or microdot " ■", may or may not be present.

^For additional information on our Pb-Free strategy and soldering
details, please download the ON Semiconductor Soldering and
Mounting Techniques Reference Manual, SOLDERRM/D.

0.48 PITCH **DIMENSIONS: MILLIMETERS**

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